

STARPOWER

SEMICONDUCTOR

IGBT

GD660HTX75P6SB

750V/660A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as hybrid and electric vehicle.

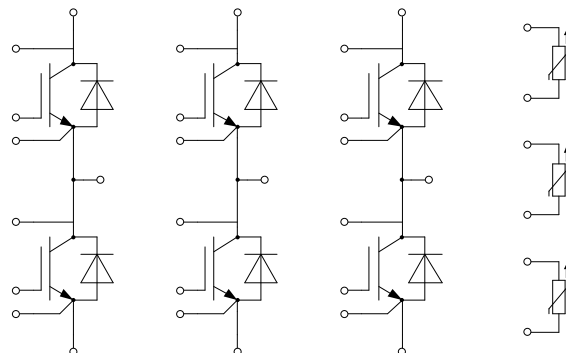
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- Low switching losses
- 6 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Automotive application
- Hybrid and electric vehicle
- Inverter for motor drive

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
V_{CES}	Collector-Emitter Voltage	750	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_{CN}	Implemented Collector Current	660	A
I_C	Collector Current @ $T_C=110^{\circ}\text{C}$	450	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1320	A
P_D	Maximum Power Dissipation @ $T_C=75^{\circ}\text{C}$ $T_J=175^{\circ}\text{C}$	1162	W

Diode

Symbol	Description	Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	750	V
I_{FN}	Implemented Collector Current	660	A
I_F	Diode Continuous Forward Current	450	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1320	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature continuous For 10s within a period of 30s, occurrence maximum 3000 times over lifetime	-40 to +150 +150 to +175	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	2500	V

IGBT Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.25	1.50	V
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		1.35		
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=175^{\circ}\text{C}$		1.40		
		$I_C=660\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.40		
		$I_C=660\text{A}, V_{GE}=15\text{V}, T_j=175^{\circ}\text{C}$		1.70		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=9.60\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.0	5.7	7.0	V
		$I_C=9.60\text{mA}, V_{CE}=V_{GE}, T_j=175^{\circ}\text{C}$		3.5		
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			0.7		Ω
C_{ies}	Input Capacitance	$V_{CE}=50\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		42.1		nF
C_{oes}	Output Capacitance			1.80		nF
C_{res}	Reverse Transfer Capacitance			1.18		nF
Q_G	Gate Charge	$V_{CE}=400\text{V}, I_C=450\text{A}, V_{GE}=-8\dots+15\text{V}$		3.01		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, L_S=24\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=25^{\circ}\text{C}$		126		ns
t_r	Rise Time			62		ns
$t_{d(off)}$	Turn-Off Delay Time			639		ns
t_f	Fall Time			149		ns
E_{on}	Turn-On Switching Loss			17.3		mJ
E_{off}	Turn-Off Switching Loss			25.4		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, L_S=24\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=150^{\circ}\text{C}$		136		ns
t_r	Rise Time			68		ns
$t_{d(off)}$	Turn-Off Delay Time			715		ns
t_f	Fall Time			221		ns
E_{on}	Turn-On Switching Loss			22.5		mJ
E_{off}	Turn-Off Switching Loss			31.0		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, L_S=24\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=175^{\circ}\text{C}$		138		ns
t_r	Rise Time			68		ns
$t_{d(off)}$	Turn-Off Delay Time			739		ns
t_f	Fall Time			227		ns
E_{on}	Turn-On Switching Loss			24.8		mJ
E_{off}	Turn-Off Switching Loss			32.6		mJ
I_{SC}	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}$		5100		A

		$T_j=25^{\circ}\text{C}, V_{CC}=400\text{V},$ $V_{CEM}\leq 750\text{V}$				
		$t_p\leq 3\mu\text{s}, V_{GE}=15\text{V},$ $T_j=175^{\circ}\text{C}, V_{CC}=400\text{V},$ $V_{CEM}\leq 750\text{V}$		3800		

Diode Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.40	1.65	V
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.35		
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.30		
		$I_F=660\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.55		
		$I_F=660\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.50		
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=7070\text{A}/\mu\text{s}, V_{GE}=-8\text{V},$ $L_S=24\text{nH}, T_j=25^{\circ}\text{C}$		16.0		μC
I_{RM}	Peak Reverse Recovery Current			254		A
E_{rec}	Reverse Recovery Energy			5.03		mJ
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=6150\text{A}/\mu\text{s}, V_{GE}=-8\text{V},$ $L_S=24\text{nH}, T_j=150^{\circ}\text{C}$		36.0		μC
I_{RM}	Peak Reverse Recovery Current			320		A
E_{rec}	Reverse Recovery Energy			9.50		mJ
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=6010\text{A}/\mu\text{s}, V_{GE}=-8\text{V},$ $L_S=24\text{nH}, T_j=175^{\circ}\text{C}$		40.5		μC
I_{RM}	Peak Reverse Recovery Current			338		A
E_{rec}	Reverse Recovery Energy			10.5		mJ

NTC Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		8		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.75		m Ω
R_{thJC}	Junction-to-Case (per IGBT)		0.077	0.086	K/W
	Junction-to-Case (per Diode)		0.125	0.150	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.054		K/W
	Case-to-Heatsink (per Diode) $\lambda_{grease}=1\text{ W}/(\text{m}\cdot\text{K})$		0.053		
M	Terminal Connection Torque, Screw M5	3.6		4.4	N.m
	Mounting Torque, Screw M4	1.8		2.2	
G	Weight of Module		605		g

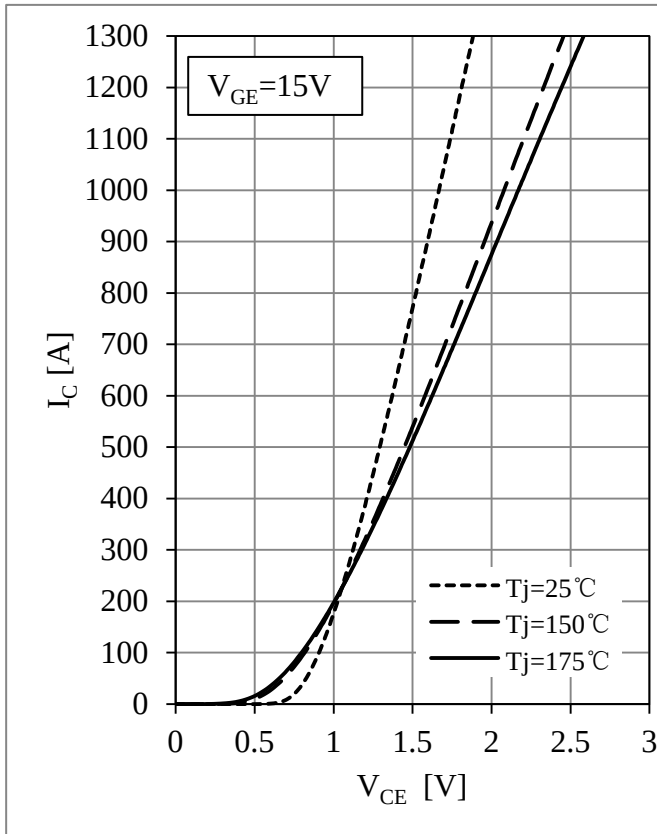


Fig 1. IGBT Output Characteristics

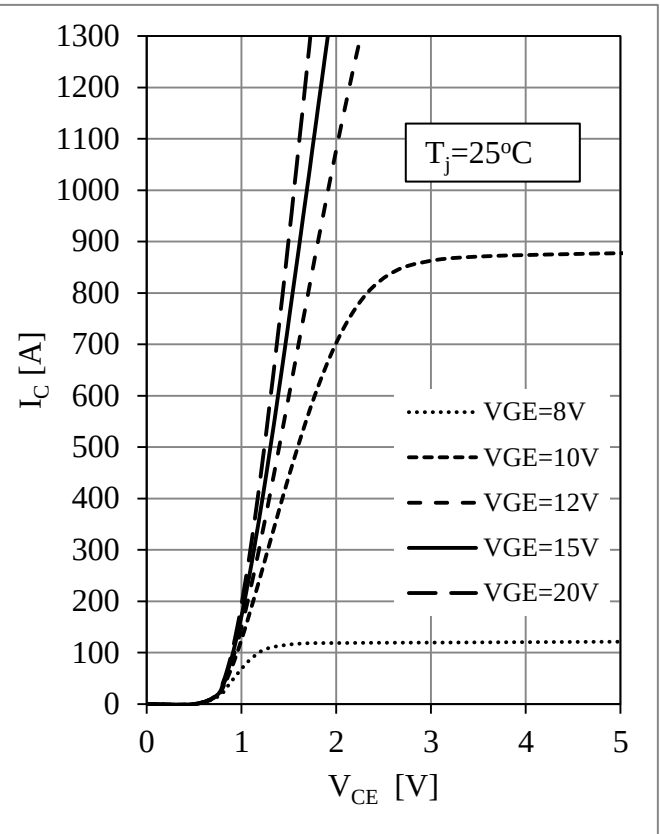


Fig 2. IGBT Output Characteristics

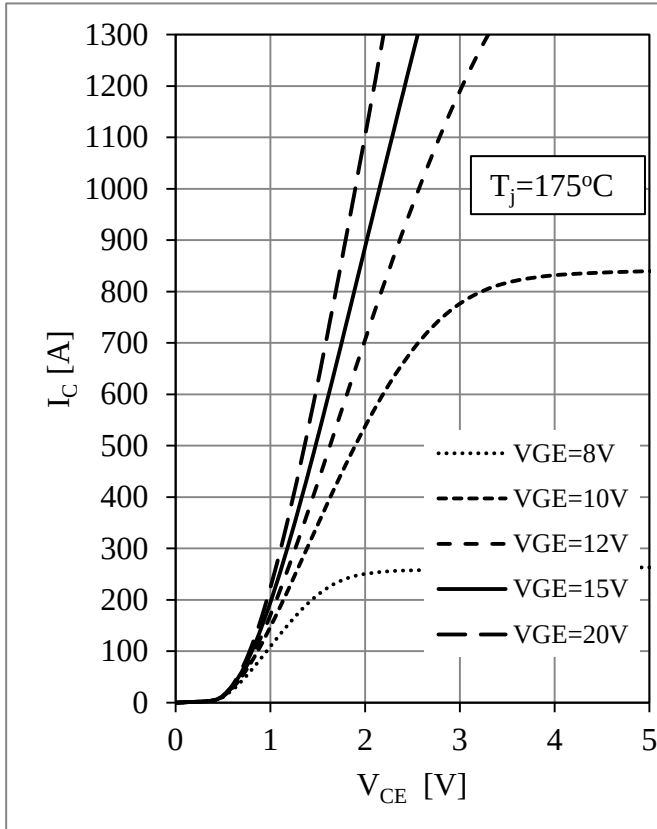


Fig 3. IGBT Output Characteristics

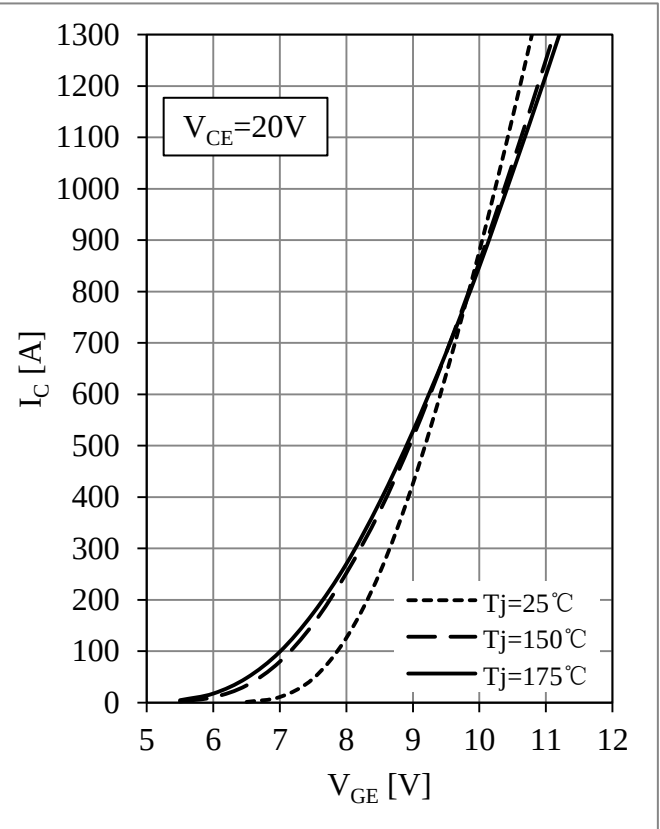


Fig 4. IGBT Transfer Characteristics

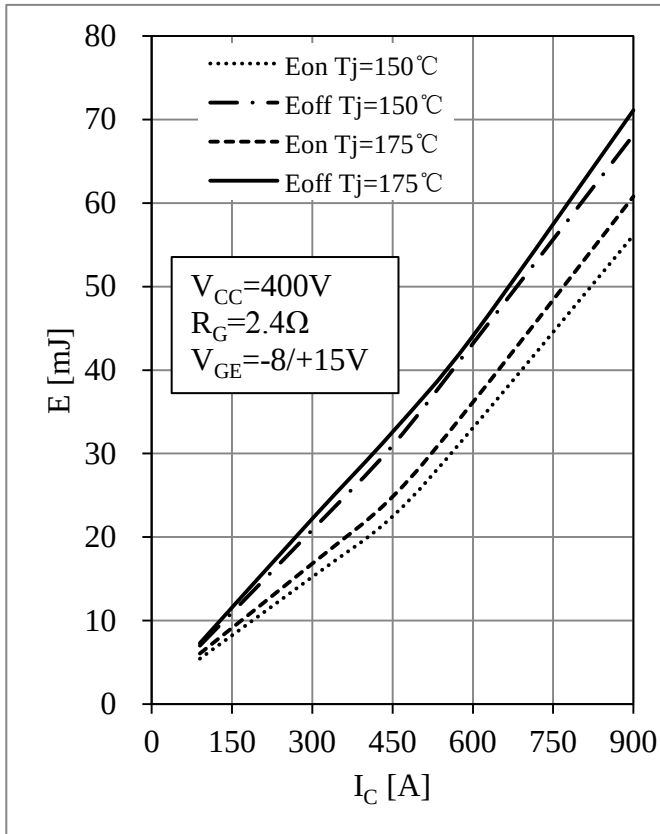
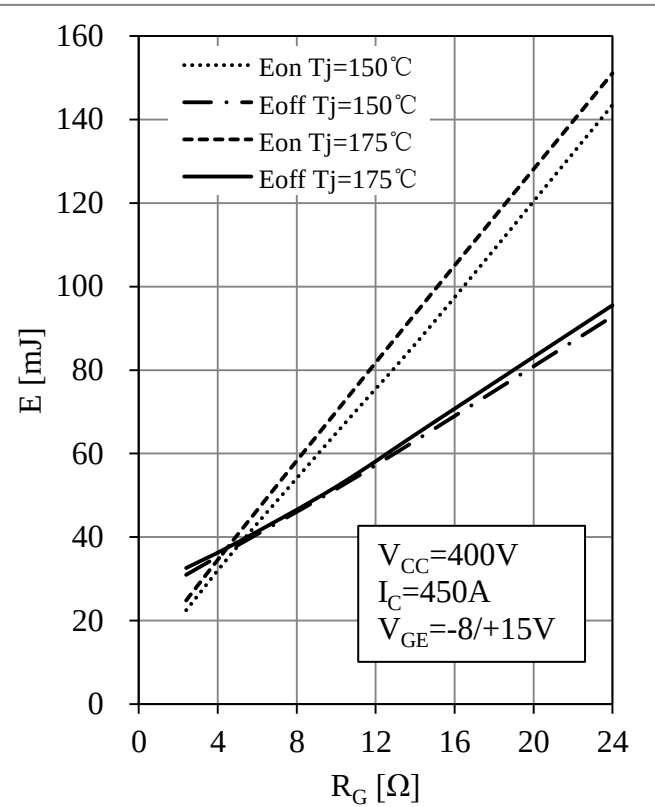
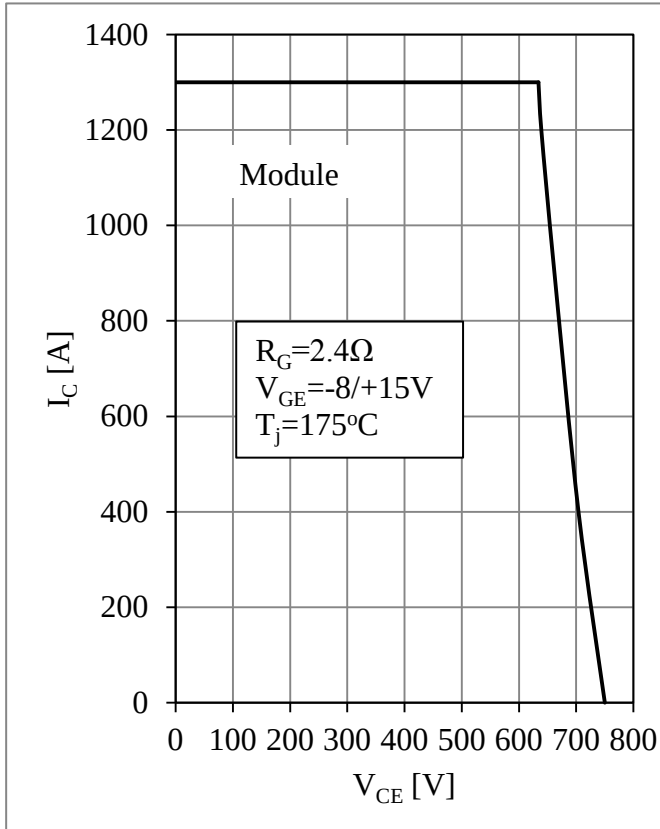
Fig 5. IGBT Switching Loss vs. I_C Fig 6. IGBT Switching Loss vs. R_G 

Fig 7. RBSOA

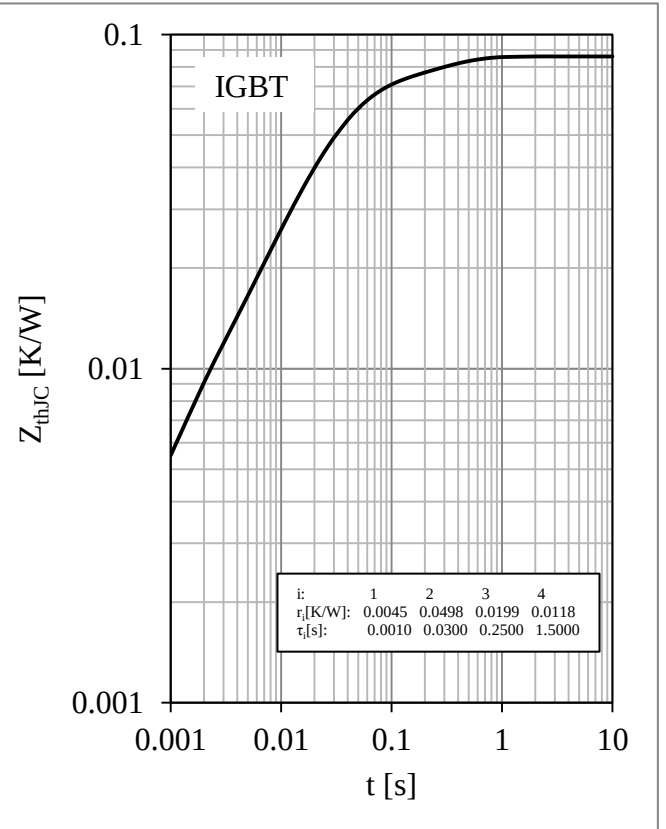


Fig 8. IGBT Transient Thermal Impedance

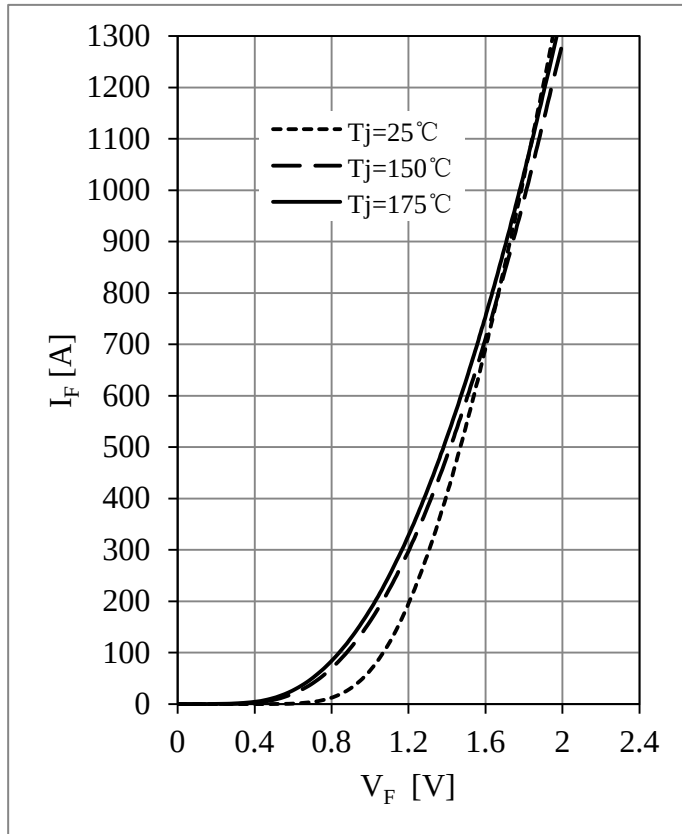


Fig 9. Diode Forward Characteristics

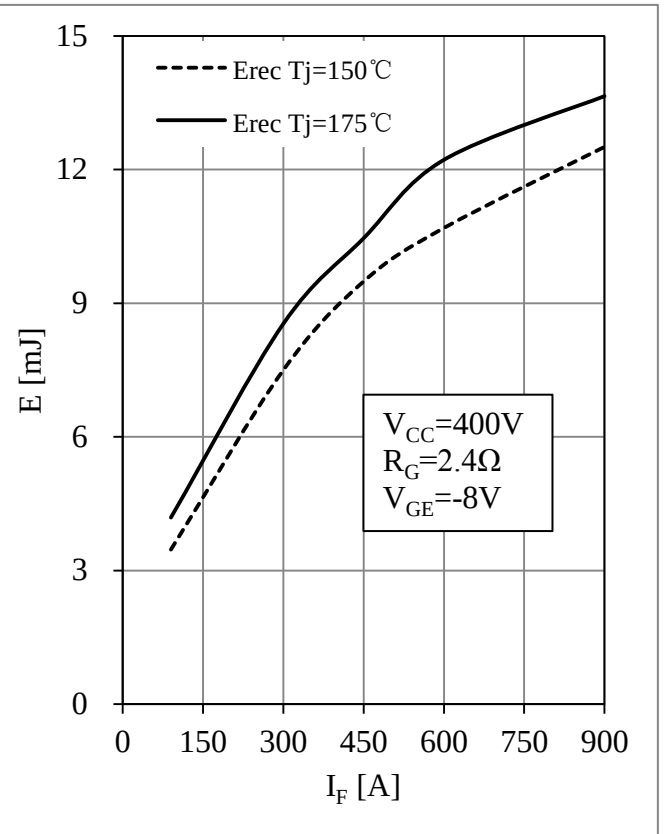
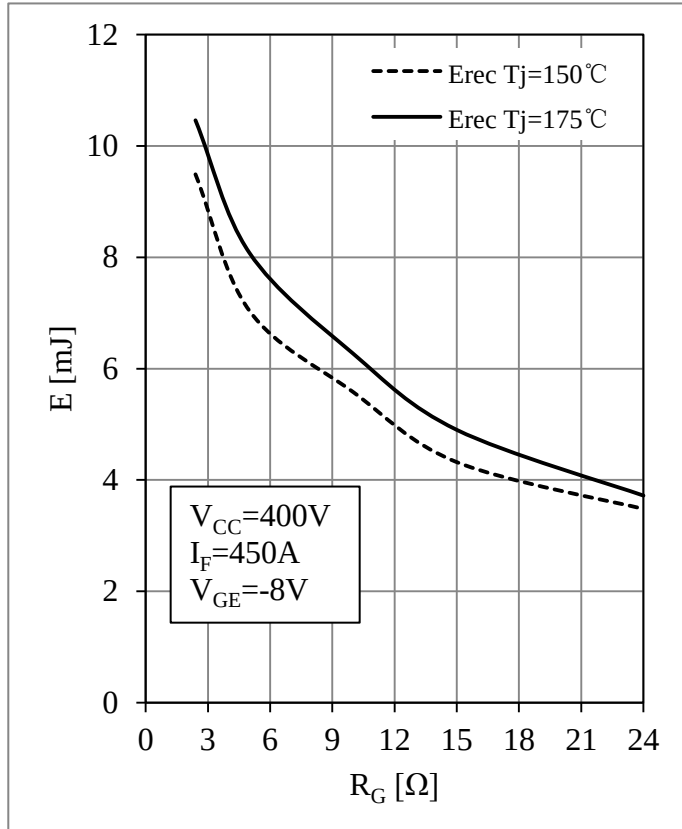
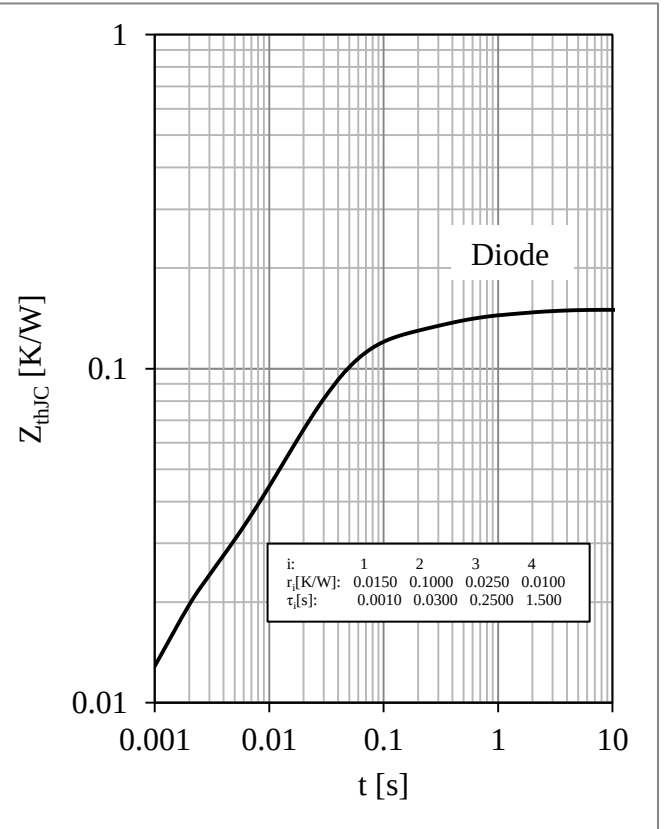
Fig 10. Diode Switching Loss vs. I_F Fig 11. Diode Switching Loss vs. R_G 

Fig 12. Diode Transient Thermal Impedance

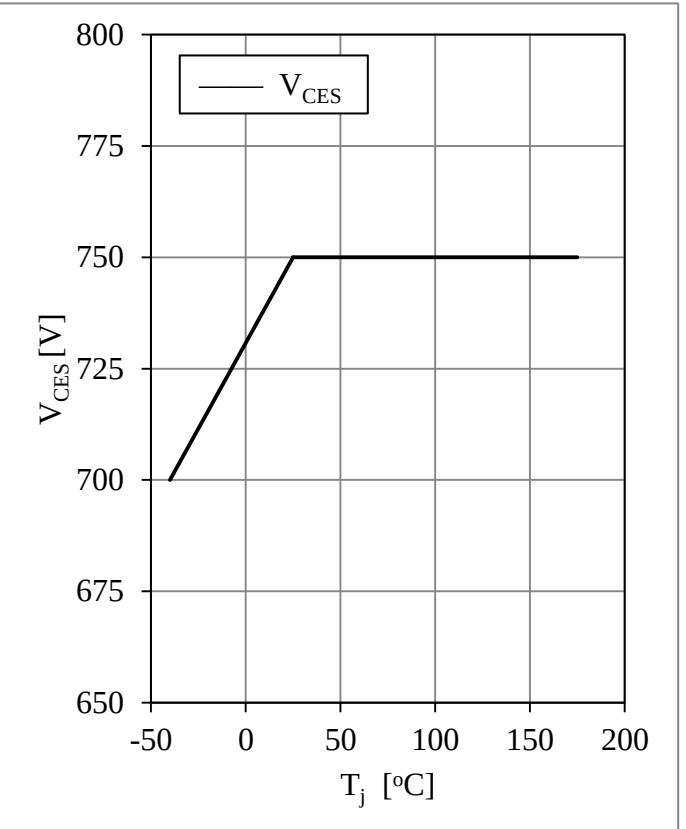
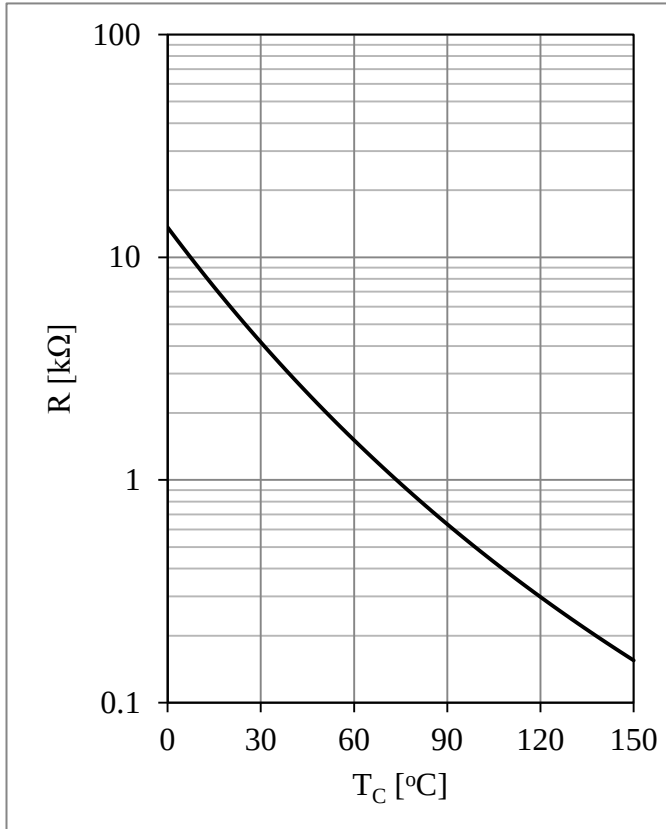
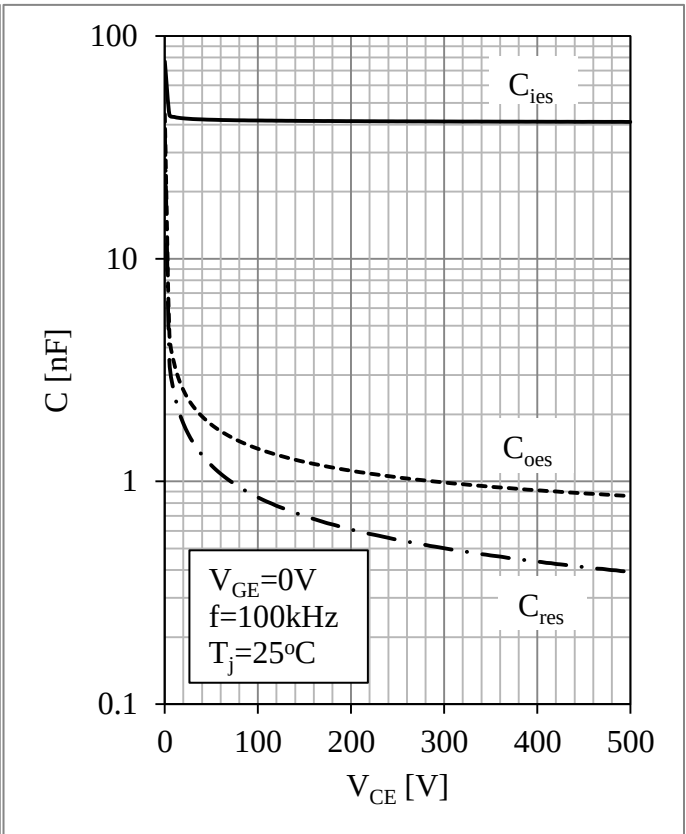
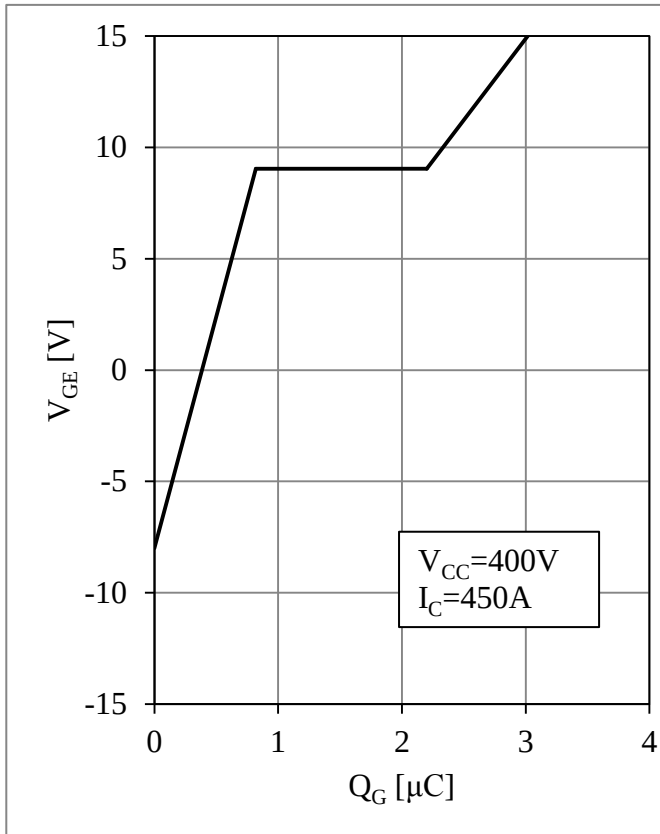
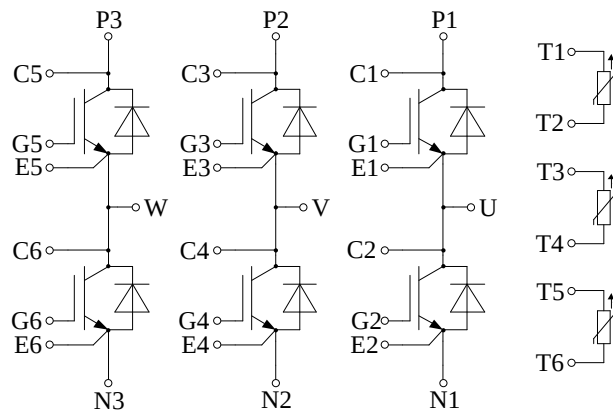


Fig 15. NTC Temperature Characteristic

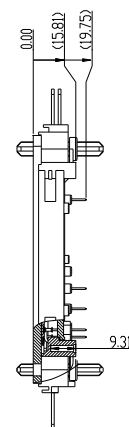
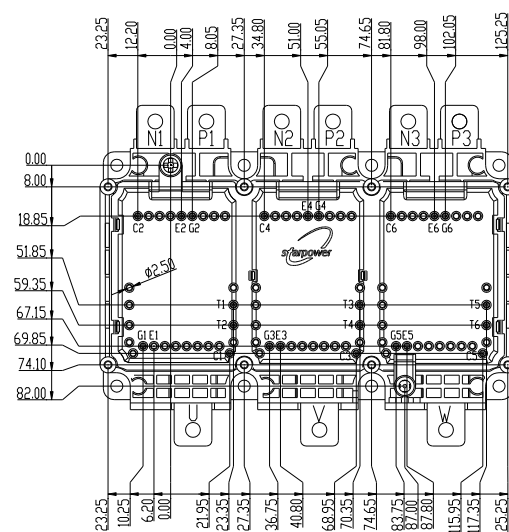
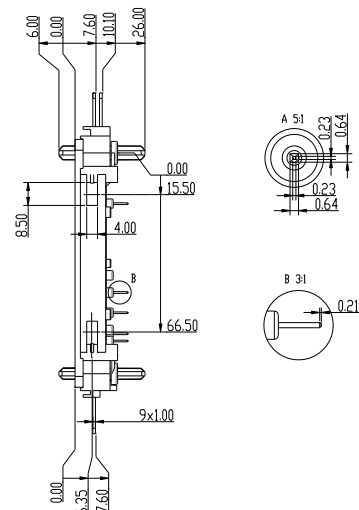
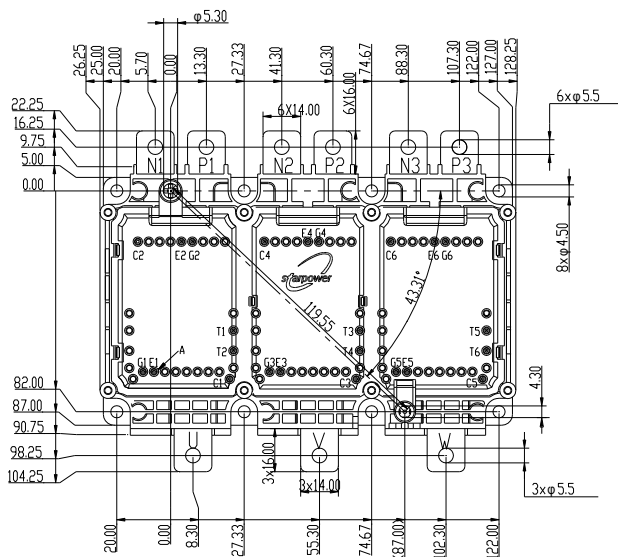
Fig 16. Maximum Allowed Collector-Emitter Voltage

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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